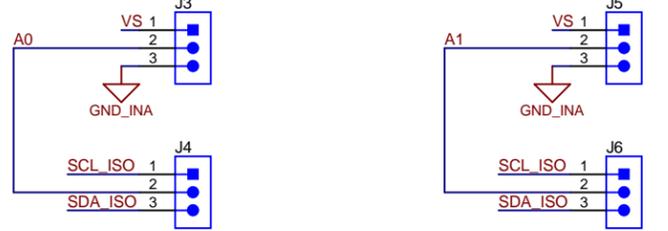


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PCB Number: TIDA-01608
PCB Rev: E1



ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Number: TIDA-01608	Rev: E1	Designed for: Texas Instruments	Mod. Date: 12/15/2017
SVN Rev: Version control disabled	Assembly Variant: 001	Project Title: TIDA-01608	Sheet: 3 of 3
Drawn By: M. Morse	File: TIDA-01608_HW.SchDoc	Sheet Title: Hardware and Logos	Size: B
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